504207756 02/01/2017

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SOMSUBHRA CHAKRABORTY	12/15/2014

RECEIVING PARTY DATA

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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15319816

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DATE SIGNED:	02/01/2017

Total Attachments: 1

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PATENT 504207756 REEL: 041146 FRAME: 0819

ASSIGNMENT OF PATENT APPLICATION

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency and adequacy of which are hereby acknowledged, the undersigned, do hereby:

SELL, ASSIGN AND TRANSFER to Ramakrishna Mission Vivekananda University(the "Assignee"), having a place of business at Howrah, Belur Math, Kokata, West Bengal, India 711202, the entire right title and interest for the United States and all foreign countries in and to any and all inventions, subject matter and improvements disclosed in the application for United States Letters Patent, Serial No. 62/013,629, which has been filled on 06/18/2014 and is entitled "Portable Apparatus for Soil Chemical Characterization," (the "Invention"), such application and any and all divisional, continuing, substitute, renewal, reissue and other applications for patent which have been or shall be filled in the United States and all foreign countries based on the Invention; all original, reissued and reexamined patents which have been or shall be issued in the United States and all foreign countries based on the Invention; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application in the United States;

AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign patents granted on such improvements to the Assignee,

WARRANT AND COVENANT that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned:

COVENANT, when requested and at the expense of the Assignee, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all such improvements; execute all rightful oaths, declarations, assignments, powers of attorney and other papers; communicate to the Assignee all facts known to the undersigned relating to such improvements and the history thereof, and generally do everything possible which the Assignee shall consider desirable for vesting title to such improvements in the Assignee, and for securing, maintaining and enforcing proper patent protection for such improvements;

TO BE BINDING on the heirs, assigns, representatives and successors of the undersigned and extend to the successors, assigns and nominees of the Assignee.

IN WITNESS WHEREOF, I have hereunto signed my name on the day and year set forth below.

Somsubhra Chakraborty 12/15/2014
Inventor's Signature Inventor's Printed Name Date

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